## CE & CE/MS Troubleshooting Guide Your guide to solving common problems and staying productive

## Places to Start

#### Solvents

- Use CE-suitable vials that are pressure resistant.
- Prepare solvent volume to be used up within one day.
- Use only HPLC-grade solvents filtered through 0.2 to 0.45 µm filters.

#### Preparing and powering up the CE

- Inspect vials and electrode for damage or precipitation. - Conditioning of uncoated capillary with MeOH, 1 M NaOH, water (5 to 10 min each), run buffer (20 min) or flush with 1 M NaOH (5 min), wait 5 min, water (5 min), run buffer (20 to 30 min).

#### Daily tasks CE-UV

- Replace background electrolyte (BGE) every day.
- Flush the capillary with 0.1 M NaOH or 10% (v/v) phosphoric acid (10 min each) depending on the pH of the BGE, followed by water (10 min) and conditioning with BGE (10 min).
- Flush the system with cleaning and storage solvent after application.

#### Storage of capillary

- A bare fused silica capillary should be cleaned properly with NaOH followed by an extensive water flush and then blown dry (with air from an empty vial).

- Coated capillaries should be stored as described in the respective product description.

#### Daily tasks CE/MS

- If the CE and MS systems are in idle state, keep the sheath solvent flow, nebulizing gas, and drying gas running.

- If you stop measuring for the day or a longer period:
- Clean and store the CE/MS capillary.
- Inspect and store the sprayer assembly.

#### BGE for CE/MS

- Nonvolatile buffers such as phosphate or borate should be avoided in CE/MS as they cause salt buildup in the electrospray chamber and in the MS inlet, which can block the inlet capillary. Instead, for low-pH separations, we recommand using volatile acidic and basic buffers, such as formic and acetic acid. For high-pH separations, we recommend ammonium salt or trialkylammonium compound buffer.



* Agilent 6550 LC/12 TOI		

## Maintenance

Agilent Lab Advisor software helps you manage your Agilent CE instrument to achieve high-quality electrophoretic results in the most efficient way by ensuring high instrument performance, productivity, and reliability. It is available free of charge.

- Diagnostic tests to evaluate performance
- Easier maintenance of Agilent 7100 CE System
- Comprehensive reports generated to ease communication with Agilent



- Clean the sheath flow splitter and the CE/MS sprayer needle.



### CE



Spikes on baseline

**Unstable baseline** 

Tailing peaks

 $\bigwedge \longrightarrow \bigwedge \bigwedge$ 

Shifting migration

 $\bigwedge \bigwedge \bigwedge \to \bigwedge \bigwedge \land$ 

times

Possible CauseSolutionEmpty capillary/wrong solutions in buffer vialsFill/change buffer vialsClogged capillaryFlush capillary with absorbing solution and a baseline jump should be observed; if still plugged, flush with hligh pressure; if not successful, replace capillaryLarge injection volume with different sample matrix (stacking)Normal condition; current should stabilize during analysisDifferent cathode/anode buffersCheck buffer identityBroken or cracked capillaryIf the current breaks down repeatedly after flushing with buffer, the capillary is probably crackedSystem shortcut (buffer on vial cap)Clean and dry cap or replacePossible CauseSolutionPrecipitates/contaminates in buffer or sampleFilter through 0.2–0.45 µm filter and verify solubilityMicroscopic bubbles in bufferDegas bufferPossible CauseSolutionOptical sit on capillary interface occludedClean with methanol or water; check with magnifying glassAgeing deuterium lampUse diode array detector (DAD) test feature to measure lamp output and time on; replacePossible CauseSolutionChanges to capillary wurlface (due to pH changesConditioning of capillary to achieve surface equilibrium and/or avoid batch- to-batch capillary distance from vial surfacePossible CauseSolutionChanges to capillary surface (due to pH changesConditioning of capillary to achieve surface equilibrium and/or avoid batch- to-batch capillary distance from vial surfaceChange in buffer composition (due to electrolysis, buffer<			
Empty capillary/wrong solutions in buffer viailsFill/change buffer viailsClogged capillaryFlush capillary with absorbing solution and a baseline jump should be observed; if still plugged, flush with high pressure; if not successful, replace capillaryLarge injection volume with different sample matrix (stacking)Normal condition; current should stabilize during analysisDifferent cathode/anode buffersCheck buffer identityBroken or cracked capillaryIf the current breaks down repeatedly after flushing with buffer, the capillary is probably crackedSystem shortcut (buffer on vial cap)Clean and dry cap or replacePossible CauseSolutionPrecipitates/contaminates in buffer or sampleFilter through 0.2–0.45 µm filter and verif y solubilityMicroscopic bubbles in bufferDegas bufferPossible CauseSolutionOptical slit on capillary interface occludedClean with methanol or water; check with magnifying glassAgeing deuterium lampUse diode array detector (DAD) test feature to measure lamp output and time on; replacePossible CauseSolutionAdsorption to capillary wallUse pH extremes, buffer additives, polymer additives, or coated capillaryCapillary end(s) damaged or resting on vial surfaceConditioning of capillary to achieve surface equilibry interface equilibry to limit bufferChanges to capillary surface (due to pH changesIncrease buffer concentation (capacity) or replenish regulary to lomit bufferPossible CauseSolutionChange in buffer composition (due to electrolysis, buffer		Possible Cause	Solution
Clogged capillaryFlush capillary with absorbing solution and a baseline jump should be observed; if still pugged, flush with high pressure; if not successful, replace capillaryLarge injection volume with different sample matrix (stacking)Normal condition; current should stabilize during analysisDifferent cathode/anode buffersCheck buffer identityBroken or cracked capillaryIf the current breaks down repeatedly after flushing with buffer, the capillary is probably crackedSystem shortcut (buffer on vial cap)Clean and dry cap or replacePossible CauseSolutionPrecipitates/contaminates in buffer or sampleFilter through 0.2–0.45 µm filter and verify solubilityMicroscopic bubbles in bufferDegas bufferPossible CauseSolutionOptical slit on capillary interface occludedUse diode array detector (DAD) test feature to measure lamp output and time or, replacePossible CauseSolutionAgeing deuterium lampUse ford array detector (DAD) test feature to measure lamp output and time or, replacePossible CauseSolutionAdsorption to capillary wall uol surfaceCheck capillary distance from vial surfaceChanges to capillary surface (due to pit changes to capillary surface or adsorption)Increase buffer concentration (capacity) or avoid batch- to-batch capillary differences; do not cycle pH (surface charge hysteresis)Change in buffer composition (due to electrolysis, buffer evaporation, conditioning waste flushed into outlet vial)Increase sample injection or concentration; particularly evident with indirect UV		Empty capillary/wrong solutions in buffer vials	Fill/change buffer vials
Large injection volume with different sample matrix (stacking)Normal condition; current should stabilize during analysisDifferent cathode/anode buffersCheck buffer identityBroken or cracked capillaryIf the current breaks down repeatedly after flushing with buffer, the capillary is probably crackedSystem shortcut (buffer on vial cap)Clean and dry cap or replacePossible CauseSolutionPrecipitates/contaminates in buffer or sampleFilter through 0.2–0.45 µm filter and verify solubilityMicroscopic bubbles in bufferDegas bufferPossible CauseSolutionOptical slit on capillary interface occludedClean with methanol or water; check with magnifying glassAgeing deuterium lampUse diode array detector (DAD) test feature to measure lamp output and time or, replacePossible CauseSolutionAdsorption to capillary wallUse pH extremes, buffer additives, polymer additives, or coated capillaryCapillary end(s) damaged or resting on vial surfaceCheck capillary ends are properly cut and check capillary distance from vial surfaceChanges to capillary surface (due to pH changes or adsorption)Increase buffer concentration (capacity) or replenish regularly to limit buffer depletion; to avoid exaporation check surface charge hysteresis)Change in buffer composition (due to electrolysis, buffer evaporation, conditioning waste flushed into outlet vial)Use replenishment for automated levelingSiphoning due to unleveled buffer vialsUse replenishment for automated levelingSample overloadDecrease sam		Clogged capillary	Flush capillary with absorbing solution and a baseline jump should be observed; if still plugged, flush with high pressure; if not successful, replace capillary
Different cathode/anode buffersCheck buffer identityBroken or cracked capillaryIf the current breaks down repeatedly after flushing with buffer, the capillary is probably crackedSystem shortcut (buffer on vial cap)Clean and dry cap or replacePossible CauseSolutionPrecipitates/contaminates in buffer or sampleFilter through 0.2–0.45 µm filter and verify solubilityMicroscopic bubbles in bufferDegas bufferPossible CauseSolutionOptical slit on capillary interface occludedClean with methanol or water; check with magnifying glassAgeing deuterium lampUse diode array detector (DAD) test feature to measure lamp output and time or; replacePossible CauseSolutionAdsorption to capillary wallUse pH extremes, buffer additives, polymer additives, or coated capillaryCapillary end(s) damaged or resting on vial surfaceCheck capillary ends are properly cut and check capillary distance from 		Large injection volume with different sample matrix (stacking)	Normal condition; current should stabilize during analysis
Broken or cracked capillaryIf the current breaks down repeatedly after flushing with buffer, the capillary is probably crackedSystem shortcut (buffer on vial cap)Clean and dry cap or replacePossible CauseSolutionPrecipitates/contaminates in buffer or sampleFilter through 0.2–0.45 µm filter and verify solubilityMicroscopic bubbles in bufferDegas bufferPossible CauseSolutionOptical slit on capillary interface occludedClean with methanol or water; check 		Different cathode/anode buffers	Check buffer identity
System shortcut (buffer on vial cap)Clean and dry cap or replacePossible CauseSolutionPrecipitates/contaminates in buffer or sampleFilter through 0.2–0.45 µm filter and verify solubilityMicroscopic bubbles in bufferDegas bufferPossible CauseSolutionOptical slit on capillary interface occludedClean with methanol or water; check with magnifying glassAgeing deuterium lampUse diode array detector (DAD) test feature to measure lamp output and time or; replacePossible CauseSolutionAdsorption to capillary wallUse H extremes, buffer additives, polymer additives, or coated CapillaryCapillary end(s) damaged or resting on vial surfaceCheck capillary ends are properly cut and check capillary distance from vial surfacePossible CauseSolutionChanges to capillary surface (due to pH changes or adsorption)Conditioning of capillary to achieve surface equilibrium and/or avoid batch- to-batch capillary differences; do not cycle pH (surface charge hysteresis)Change in buffer composition (due to electrolysis, buffer evaporation, conditioning waste flushed into outlet vial)Increase buffer concentration (capacity) or replenish regularly to limit buffer depletion; to avoid evaporation check seal on vial caps, check destination of conditioning wasteSiphoning due to unleveled buffer vialsUse replenishment for automated levelingSample overloadDecrease sample injection or concentration; particularly evident with indirect UV detection of small ions		Broken or cracked capillary	If the current breaks down repeatedly after flushing with buffer, the capillary is probably cracked
Possible CauseSolutionPrecipitates/contaminates in buffer or sampleFilter through 0.2–0.45 µm filter and verify solubilityMicroscopic bubbles in bufferDegas bufferPossible CauseSolutionOptical slit on capillary interface occludedClean with methanol or water; check with magnifying glassAgeing deuterium lampUse diode array detector (DAD) test feature to measure lamp output and time on; replacePossible CauseSolutionAdsorption to capillary wallUse pH extremes, buffer additives, 		System shortcut (buffer on vial cap)	Clean and dry cap or replace
Precipitates/contaminates in buffer or sampleFilter through 0.2–0.45 µm filter and verify solubilityMicroscopic bubbles in bufferDegas bufferPossible CauseSolutionOptical slit on capillary interface occludedClean with methanol or water; check with magnifying glassAgeing deuterium lampUse diode array detector (DAD) test feature to measure lamp output and time on; replacePossible CauseSolutionAdsorption to capillary wallUse pH extremes, buffer additives, polymer additives, or coated capillaryCapillary end(s) damaged or resting on vial surfaceCheck capillary ends are properly cut and check capillary distance from vial surfacePossible CauseSolutionChanges to capillary surface (due to pH changes or adsorption)Conditioning of capillary to achieve surface equilibrium and/or avoid batch- to-batch capillary differences; do not cycle pH (surface charge hysteresis)Change in buffer composition (due to electrolysis, buffer evaporation, conditioning waste flushed into outlet vial)Increase buffer concentration (capacity) or replenish regularly to limit buffer evaporation check seal on vial caps, check destination of conditioning wasteSiphoning due to unleveled buffer vialsUse replenishment for automated levelingSample overloadDecrease sample injection or concentration; particularly evident with indirect UV detection of small ions		Possible Cause	Solution
Microscopic bubbles in bufferDegas bufferPossible CauseSolutionOptical slit on capillary interface occludedClean with methanol or water, check with magnifying glassAgeing deuterium lampUse diode array detector (DAD) test feature to measure lamp output and time on; replacePossible CauseSolutionAdsorption to capillary wallUse pH extremes, buffer additives, polymer additives, or coated capillaryCapillary end(s) damaged or resting on vial surfaceCheck capillary ends are properly cut and check capillary distance from vial surfacePossible CauseSolutionChanges to capillary surface (due to pH changes or adsorption)Conditioning of capillary to achieve surface equilibrium and/or avoid batch- to-batch capillary differences; do not cycle pH (surface charge hysteresis)Change in buffer composition (due to electrolysis, buffer evaporation, conditioning waste flushed into outlet vial)Increase buffer concentration (capacity) or replenish regularly to limit buffer evaporation, conditioning wasteSiphoning due to unleveled buffer vialsUse replenishment for automated levelingSample overloadDecrease sample injection or concentration, particularly evident with indirect UV detection of small ions		Precipitates/contaminates in buffer or sample	Filter through 0.2–0.45 µm filter and verify solubility
Possible CauseSolutionOptical slit on capillary interface occludedClean with methanol or water; check with magnifying glassAgeing deuterium lampUse diode array detector (DAD) test feature to measure lamp output and time on; replacePossible CauseSolutionAdsorption to capillary wallUse pH extremes, buffer additives, polymer additives, or coated capillaryCapillary end(s) damaged or resting on vial surfaceCheck capillary ends are properly cut and check capillary distance from vial surfacePossible CauseSolutionChanges to capillary surface (due to pH changes or adsorption)Conditioning of capillary to achieve surface equilibrium and/or avoid batch- to-batch capillary differences; do not cycle pH (surface charge hysteresis)Change in buffer composition (due to electrolysis, buffer evaporation, conditioning waste flushed into outlet vial)Increase buffer concentration (capacity) or replenish regularly to limit buffer depletion; to avoid evaporation check seal on vial caps, check destination of conditioning wasteSiphoning due to unleveled buffer vialsUse replenishment for automated levelingSample overloadDecrease sample injection or concentration; particularly evident with indirect UV detection of small ions		Microscopic bubbles in buffer	Degas buffer
Possible CauseSolutionOptical slit on capillary interface occludedClean with methanol or water; check with magnifying glassAgeing deuterium lampUse diode array detector (DAD) test feature to measure lamp output and time on; replacePossible CauseSolutionAdsorption to capillary wallUse pH extremes, buffer additives, polymer additives, or coated capillaryCapillary end(s) damaged or resting on vial surfaceCheck capillary ends are properly cut and check capillary distance from vial surfacePossible CauseSolutionChanges to capillary surface (due to pH changes or adsorption)Conditioning of capillary to achieve surface equilibrium and/or avoid batch- to-batch capillary differences; do not cycle pH (surface charge hysteresis)Change in buffer composition (due to electrolysis, buffer evaporation, conditioning waste flushed into outlet vial)Increase buffer concentration (capacity) or replenish regularly to limit buffer depletion; to avoid evaporation check seal on vial caps, check destination of conditioning wasteSiphoning due to unleveled buffer vialsUse replenishment for automated levelingSample overloadDecrease sample injection or concentration; particularly evident with indirect UV detection of small ions			
Optical sit on capillary interface occludedClean with methanol or water; check with magnifying glassAgeing deuterium lampUse diode array detector (DAD) test feature to measure lamp output and time on; replacePossible CauseSolutionAdsorption to capillary wallUse pH extremes, buffer additives, polymer additives, or coated capillaryCapillary end(s) damaged or resting on vial surfaceCheck capillary ends are properly cut and check capillary distance from vial surfacePossible CauseSolutionChanges to capillary surface (due to pH changes or adsorption)Conditioning of capillary to achieve surface charge hysteresis)Change in buffer composition (due to electrolysis, buffer evaporation, conditioning waste flushed into outlet vial)Increase buffer concentration (capacity) or replenish regularly to limit buffer depletion; to avoid evaporation check seal on vial caps, check destination of conditioning wasteSiphoning due to unleveled buffer vialsUse replenishment for automated levelingSample overloadDecrease sample injection or concentration; particularly evident with indirect UV detection of small ions		Possible Cause	Solution
Ageing deuterium lampUse diode array detector (DAD) test feature to measure lamp output and time on; replacePossible CauseSolutionAdsorption to capillary wallUse pH extremes, buffer additives, polymer additives, or coated capillaryCapillary end(s) damaged or resting on vial surfaceCheck capillary ends are properly cut and check capillary distance from vial surfacePossible CauseSolutionChanges to capillary surface (due to pH changes or adsorption)Conditioning of capillary to achieve surface equilibrium and/or avoid batch- to-batch capillary differences; do not cycle pH (surface charge hysteresis)Change in buffer composition (due to electrolysis, buffer evaporation, conditioning waste flushed into outlet vial)Increase buffer concentration (capacity) or replenish regularly to limit buffer depletion; to avoid evaporation check seal on vial caps, check destination of conditioning wasteSiphoning due to unleveled buffer vialsUse replenishment for automated levelingSample overloadDecrease sample injection or concentration; particularly evident with indirect UV detection of small ions		interface occluded	with magnifying glass
Possible CauseSolutionAdsorption to capillary wallUse pH extremes, buffer additives, polymer additives, or coated capillaryCapillary end(s) damaged or resting on vial surfaceCheck capillary ends are properly cut and check capillary distance from vial surfacePossible CauseSolutionChanges to capillary surface (due to pH changes or adsorption)Conditioning of capillary to achieve surface equilibrium and/or avoid batch- to-batch capillary differences; do not cycle pH (surface charge hysteresis)Change in buffer composition (due to electrolysis, buffer evaporation, conditioning waste flushed into outlet vial)Increase buffer concentration (capacity) or replenish regularly to limit buffer depletion; to avoid evaporation check seal on vial caps, check destination of conditioning wasteSiphoning due to unleveled buffer vialsUse replenishment for automated levelingSample overloadDecrease sample injection or concentration; particularly evident with indirect UV detection of small ions	-	Ageing deuterium lamp	Use diode array detector (DAD) test feature to measure lamp output and time on; replace
Possible CauseSolutionAdsorption to capillary wallUse pH extremes, buffer additives, polymer additives, or coated capillaryCapillary end(s) damaged or resting on vial surfaceCheck capillary ends are properly cut and check capillary distance from vial surfacePossible CauseSolutionChanges to capillary surface (due to pH changes or adsorption)Conditioning of capillary to achieve 			
Capillary end(s) damaged or resting on vial surfaceCheck capillary ends are properly cut and check capillary distance from vial surfacePossible CauseSolutionChanges to capillary surface (due to pH changes or adsorption)Conditioning of capillary to achieve surface equilibrium and/or avoid batch- to-batch capillary differences; do not cycle pH (surface charge hysteresis)Change in buffer composition (due to electrolysis, buffer evaporation, conditioning waste flushed into outlet vial)Increase buffer concentration (capacity) or replenish regularly to limit buffer depletion; to avoid evaporation check seal on vial caps, check destination of conditioning wasteSiphoning due to unleveled buffer vialsUse replenishment for automated levelingSample overloadDecrease sample injection or concentration; particularly evident with indirect UV detection of small ions		Possible Cause Adsorption to capillary wall	Solution Use pH extremes, buffer additives, polymer additives, or coated capillary
Possible CauseSolutionChanges to capillary surface (due to pH changes or adsorption)Conditioning of capillary to achieve surface equilibrium and/or avoid batch- to-batch capillary differences; do not cycle pH (surface charge hysteresis)Change in buffer composition (due to electrolysis, buffer evaporation, conditioning waste flushed into outlet vial)Increase buffer concentration (capacity) or replenish regularly to limit buffer 	-	Capillary end(s) damaged or resting on vial surface	Check capillary ends are properly cut and check capillary distance from vial surface
Possible CauseSolutionChanges to capillary surface (due to pH changes or adsorption)Conditioning of capillary to achieve surface equilibrium and/or avoid batch- to-batch capillary differences; do not cycle pH (surface charge hysteresis)Change in buffer composition (due to electrolysis, buffer 		<b>D</b>	
Changes to capiliary surface (due to pH changes or adsorption)Conditioning of capillary to achieve surface equilibrium and/or avoid batch- to-batch capillary differences; do not cycle pH (surface charge hysteresis)Change in buffer composition (due to electrolysis, buffer evaporation, conditioning waste flushed into outlet vial)Increase buffer concentration (capacity) or replenish regularly to limit buffer depletion; to avoid evaporation check seal on vial caps, check destination of conditioning wasteSiphoning due to unleveled buffer vialsUse replenishment for automated levelingSample overloadDecrease sample injection or concentration; particularly evident with indirect UV detection of small ions		Possible Cause	Solution
Change in buffer composition (due to electrolysis, buffer evaporation, conditioning waste flushed into outlet vial)Increase buffer concentration (capacity) or replenish regularly to limit buffer depletion; to avoid evaporation check seal on vial caps, check destination of conditioning wasteSiphoning due to unleveled buffer vialsUse replenishment for automated levelingSample overloadDecrease sample injection or concentration; particularly evident with indirect UV detection of small ions		Changes to capillary surface (due to pH changes or adsorption)	Conditioning of capillary to achieve surface equilibrium and/or avoid batch- to-batch capillary differences; do not cycle pH (surface charge hysteresis)
Siphoning due to unleveled buffer vialsUse replenishment for automated levelingSample overloadDecrease sample injection or concentration; particularly evident with indirect UV detection of small ions		Change in buffer composition (due to electrolysis, buffer evaporation, conditioning waste flushed into outlet vial)	Increase buffer concentration (capacity) or replenish regularly to limit buffer depletion; to avoid evaporation check seal on vial caps, check destination of conditioning waste
Sample overload Decrease sample injection or concentration; particularly evident with indirect UV detection of small ions		Siphoning due to unleveled buffer vials	Use replenishment for automated leveling
		Sample overload	Decrease sample injection or concentration; particularly evident with indirect UV detection of small ions

# 

Get answers. Share insights. Join the Agilent Community:



For Lab Advisor software, please visit: www.agilent.com/chem/lab-advisor



## CE/MS

Current unstable/	Possible Cause	Solution
spiky/too low	Poor electrical contact at sprayer tip	Adjust axial position of the CE capillary in the CE-ESI-MS sprayer
	Bubble formation at the sprayer needle	Increase the sheath liquid flow rate to flush out electrolysis gas
CE ourront brooks	Possible Cause	Solution
down after injection	A liquid gap is formed in the BGE by the suction effect formed by the nebulizing gas	Time program the nebulizing gas pressure during the injection time to a low value
	A liquid gap is formed by siphoning towards the capillary outlet	Check the height level of the inlet and the height of the sprayer
	Possible Cause	Solution
signal (TIC) varies	The sheath solvent flow rate is unstable, is fluctuating, and/or is poorly degassed	Use recommended isocratic pump with online degassing
VVVV	Polyimide of the CE capillary has swollen or has become detached	Avoid the use of high concentration of acetonitril in BGE and/or sheath solvent
Decreased migration	Possible Cause	Solution
times and wider peaks $AAA \rightarrow AAAA$	Hydraulic flow exists towards the capillary outlet	Check level of inlet vial and height of sprayer to avoid siphoning; reduce nebulizing gas pressure to avoid suction effect
FSI current is unstable	Possible Cause	Solution
or too low	Drying gas flow rate too high	Reduce drying gas flow rate as much as possible
Poor reproducability	Possible Cause	Solution
of peak heights (TIC)	Variability of ionization efficiency	Use deuterated analogs of your solutes as internal standard
$\bigwedge \to \bigwedge \to \bigwedge$	Low injection precision of the CE instrument: field variation on the inlet side of the CE capillary as cut or damaged	Use internal standard
De demo de MO	Possible Cause	Solution
Background MS current too high	Dirty spray needle, CE capillary or sheath liquid pump	Flush capillary and clean spray needle or the the sheath liquid pump
	Dirty BGE or sheath liquid	Use utmost cleanliness in all parts of your system

More troubleshooting information can be found in the following Agilent publications:

- High Performance Capillary Electrophoresis (primer, 5990-3777EN) - CE/MS Principles and Practices (guidebook, 5994-0112EN)

> DE24214671 This information is subject to change without notice © Agilent Technologies, Inc. 2022 Printed in the USA, October 1, 2022

